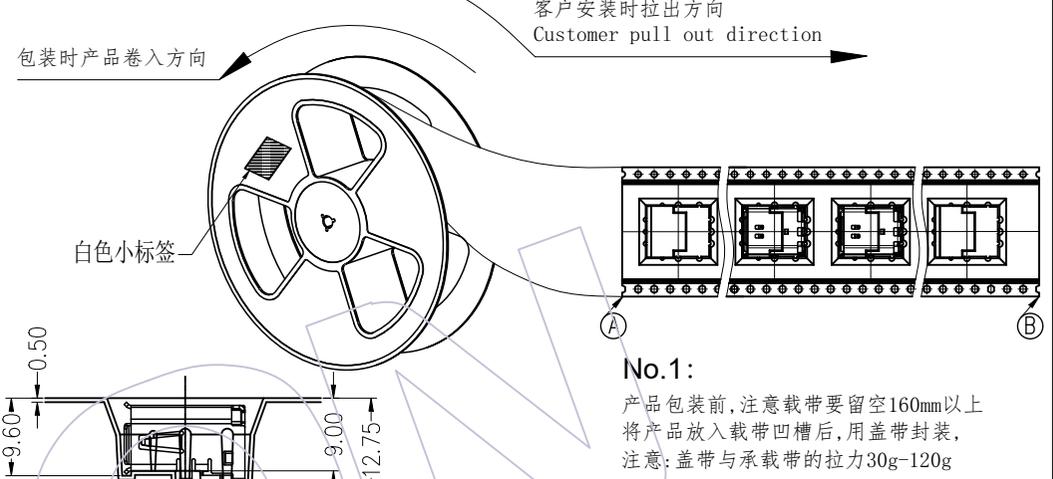
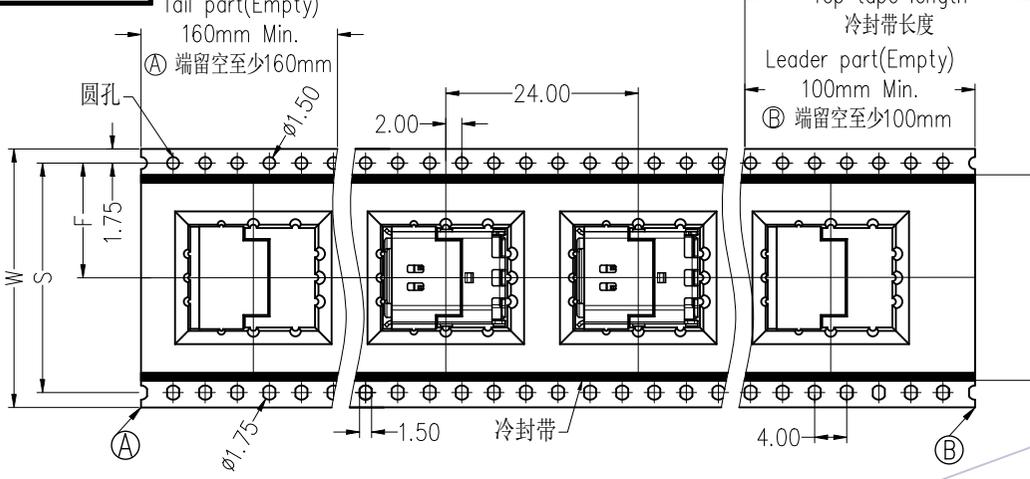
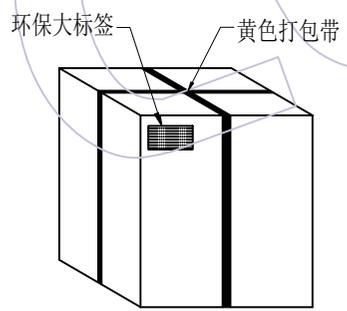


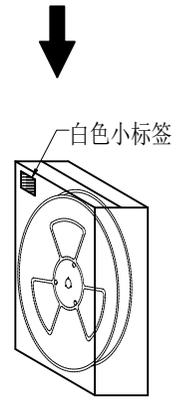
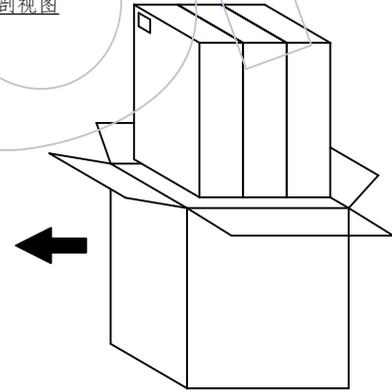
# HSF



**No.1:**  
产品包装前,注意载带要留空160mm以上  
将产品放入载带凹槽后,用盖带封装,  
注意:盖带与承载带的拉力30g-120g



外箱: CTN-18K



内箱: CTN-18E

**No.4:**  
封箱, 打包, 贴标签。

**No.3:**  
将内箱装入外箱 (3内箱/外箱)  
注意统一标签方向

**No.2:**  
将卷盘套上PE-32防水袋,  
放入1包干燥剂,  
真空机封口后装入内箱,  
用封箱胶封装好,并贴上标签。

PIN	载带料号	W	S	F	PCS/Reel	PCS/内箱	PCS/外箱
06	TR6363-FN006R12001	24.0 ± 0.30	/	11.50 ± 0.15	190	570	1710
08	TR6363-FN008R12001	24.0 ± 0.30	/	11.50 ± 0.15	190	570	1710
10	TR6363-FN010R12001	32.0 ± 0.30	28.40 ± 0.15	14.50 ± 0.15	190	380	1140

变更记录	版次	日期	变更说明	变更	核准
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	
A0	2021/09/03	NEW	-----	-----	

工程图	绘图	苏珊	2021/09/03	SCALE	FIT
ENGINEERING	DRAW				
X.X	±0.30	设计		UNIT	mm
X.XX	±0.20	DESIGN		SIZE	A4
X.XXX	±0.10	审核		SHEET	1/1
Angle	± 2'	CHECK		PROJ.	
DIM	TOL	核准			
		APPROVE			

料号 PART NO.		6363-XXRXXGBNR1	
品名 TITLE:		0.8mm Micro IO 母座, 90° DIP Type 卷装规范	
<b>WCON</b>			
WCON ELECTRONICS (GUANGDONG) CO., LTD			